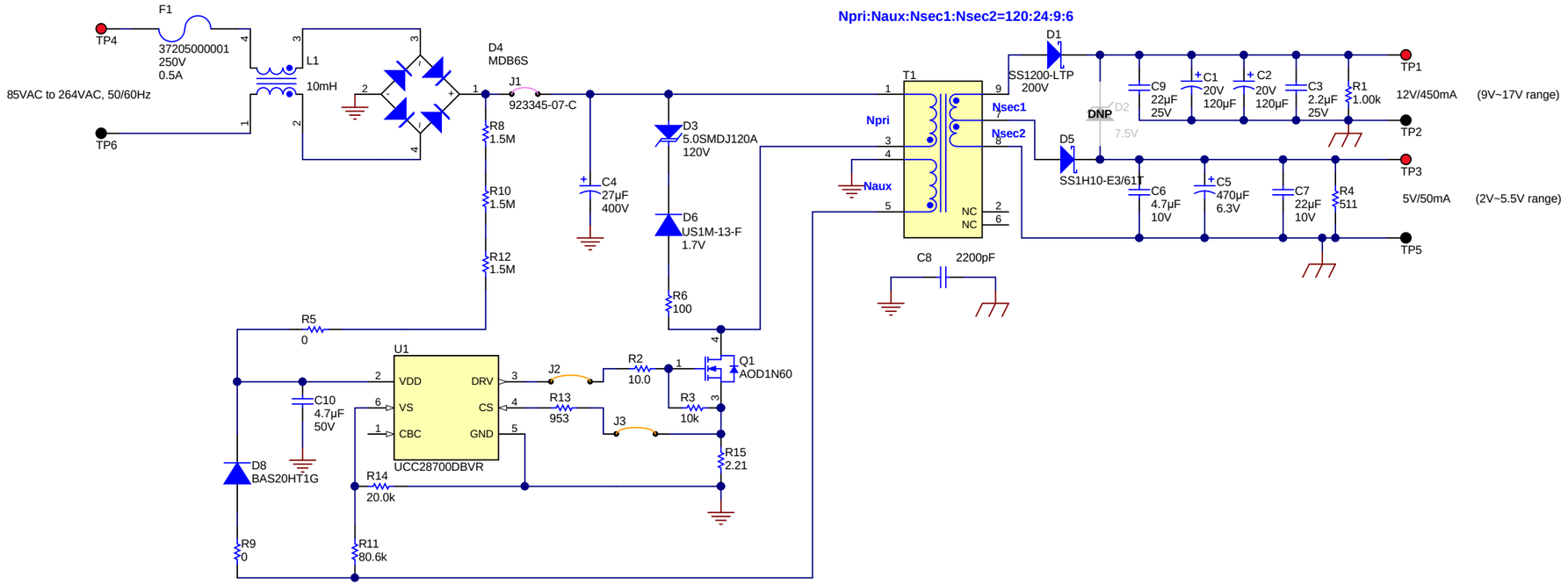


PCB Number: PMP20339
PCB Rev: A

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TID #: N/A	Project Title: UCC28700 dual-output Flyback	
Number: PMP20339 Rev: A	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 1
Drawn By:	File: PMP20315_BlankSheet.SchDoc	Size: B
Engineer: Sheng-Yang Yu , AdamLin	Contact: http://www.ti.com/support	

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